

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Phase-out/Discontinued

**SWITCHING
N-CHANNEL POWER MOS FET**

DESCRIPTION

The 2SK3304 is N-Channel MOS FET device that features a Low gate charge and excellent switching characteristics, and designed for high voltage applications such as switching power supply.

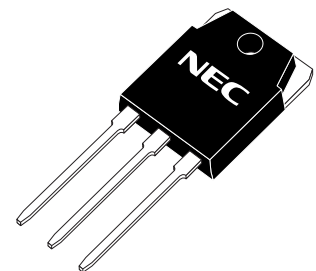
FEATURES

- Low gate charge :
 $Q_G = 44 \text{ nC TYP. (} V_{DD} = 450 \text{ V, } V_{GS} = 10 \text{ V, } I_D = 7.0 \text{ A)}$
- Gate voltage rating : $\pm 30 \text{ V}$
- Low on-state resistance :
 $R_{DS(on)} = 2.0 \Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 4.0 \text{ A)}$
- Avalanche capability ratings

ORDERING INFORMATION

| PART NUMBER | PACKAGE |
|-------------|---------|
| 2SK3304 | TO-3P |

(TO-3P)



ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

| | | | |
|---|----------------|-------------|----|
| Drain to Source Voltage | V_{DSS} | 900 | V |
| Gate to Source Voltage | $V_{GSS(AC)}$ | ± 30 | V |
| Drain Current (DC) | $I_{D(DC)}$ | ± 7 | A |
| Drain Current (Pulse) ^{Note1} | $I_{D(pulse)}$ | ± 21 | A |
| Total Power Dissipation (TC = 25°C) | P_{T1} | 130 | W |
| Total Power Dissipation (TA = 25°C) | P_{T2} | 3.0 | W |
| Storage Temperature | T_{stg} | -55 to +150 | °C |
| Single Avalanche Current ^{Note2} | I_{AS} | 7 | A |
| Single Avalanche Energy ^{Note2} | E_{AS} | 147 | mJ |

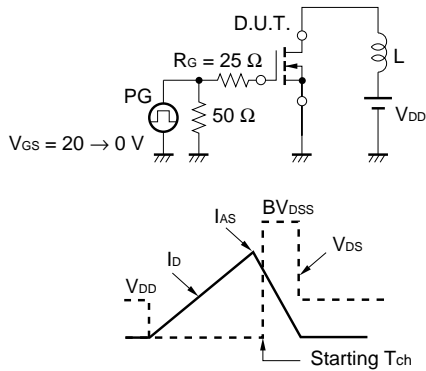
- Notes** 1. $PW \leq 10 \mu s$, Duty cycle $\leq 1 \%$
 2. Starting $T_{ch} = 25^\circ C$, $V_{DD} = 150 \text{ V}$, $R_G = 25 \Omega$, $V_{GS} = 20 \rightarrow 0 \text{ V}$

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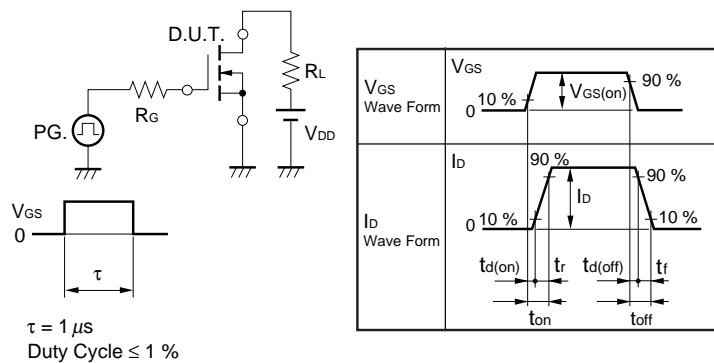
ELECTRICAL CHARACTERISTICS (T_A = 25°C)

| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------|----------------------|---|------|------|------|------|
| Drain Leakage Current | I _{DSS} | V _{DS} = 900 V, V _{GS} = 0 V | | | 100 | μA |
| Gate to Source Leakage Current | I _{GSS} | V _{GS} = ±30 V, V _{DS} = 0 V | | | ±100 | nA |
| Gate to Source Cut-off Voltage | V _{GS(off)} | V _{DS} = 10 V, I _D = 1.0 mA | 2.5 | | 3.5 | V |
| Forward Transfer Admittance | y _{fs} | V _{DS} = 20 V, I _D = 4.0 A | 2.5 | 4.7 | | S |
| Drain to Source On-state Resistance | R _{DS(on)} | V _{GS} = 10 V, I _D = 4.0 A | | 1.6 | 2.0 | Ω |
| Input Capacitance | C _{iss} | V _{DS} = 10 V | | 1300 | | pF |
| Output Capacitance | C _{oss} | V _{GS} = 0 V | | 240 | | pF |
| Reverse Transfer Capacitance | C _{rss} | f = 1 MHz | | 55 | | pF |
| Turn-on Delay Time | t _{d(on)} | V _{DD} = 150 V | | 20 | | ns |
| Rise Time | t _r | I _D = 4.0 A | | 44 | | ns |
| Turn-off Delay Time | t _{d(off)} | V _{GS} = 10 V | | 73 | | ns |
| Fall Time | t _f | R _G = 10 Ω, R _L ≅ 36 Ω | | 45 | | ns |
| Total Gate Charge | Q _G | V _{DD} = 450 V | | 44 | | nC |
| Gate to Source Charge | Q _{GS} | V _{GS} = 10 V | | 6 | | nC |
| Gate to Drain Charge | Q _{GD} | I _D = 7.0 A | | 28 | | nC |
| Body Diode Forward Voltage | V _{F(S-D)} | I _F = 7.0 A, V _{GS} = 0 V | | 1.0 | | V |
| Reverse Recovery Time | t _{rr} | I _F = 7.0 A, V _{GS} = 0 V | | 2.4 | | μs |
| Reverse Recovery Charge | Q _{rr} | di/dt = 50 A/μs | | 13.5 | | μC |

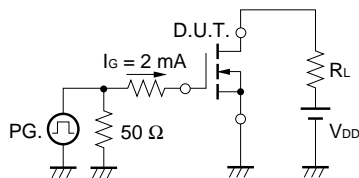
TEST CIRCUIT 1 AVALANCHE CAPABILITY



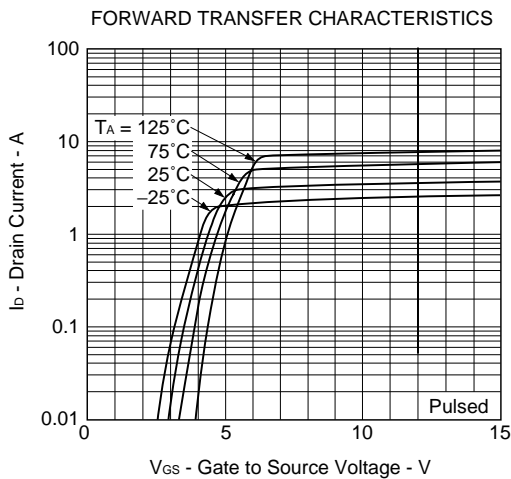
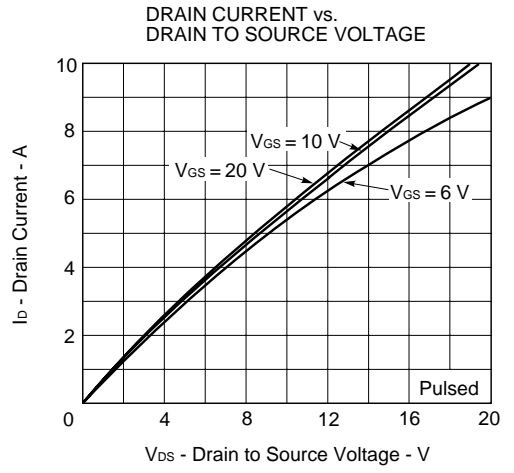
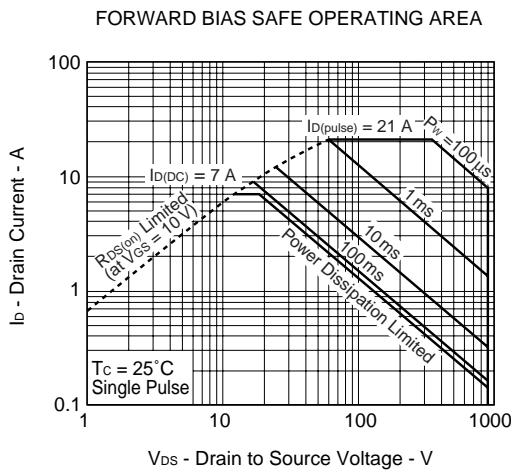
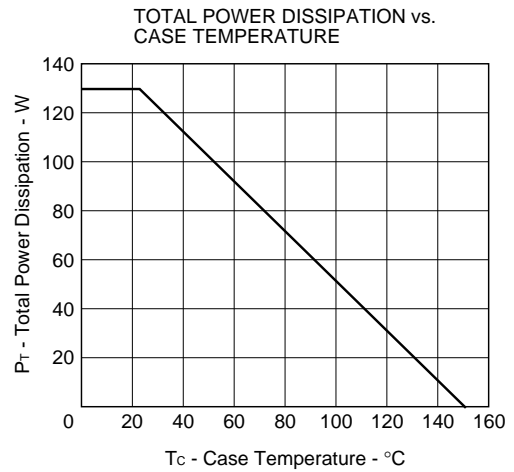
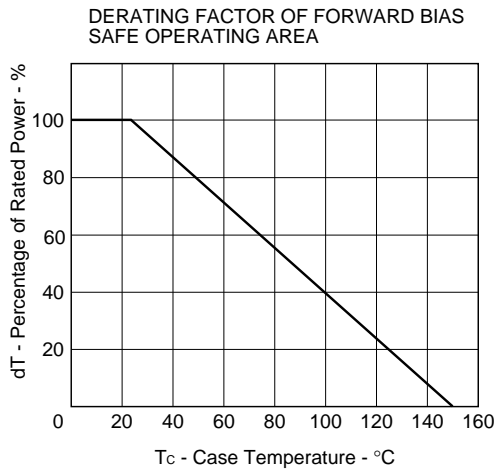
TEST CIRCUIT 2 SWITCHING TIME



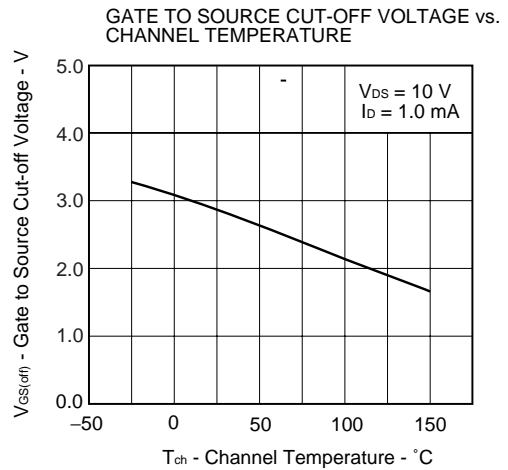
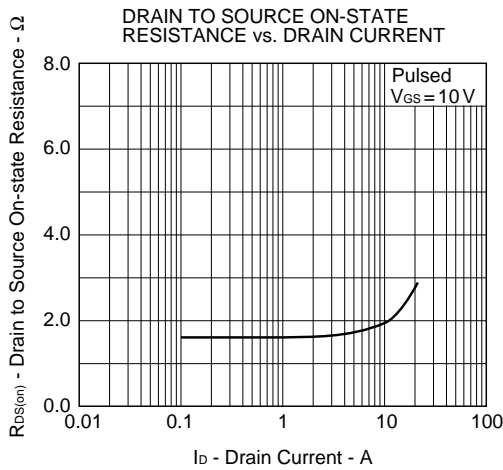
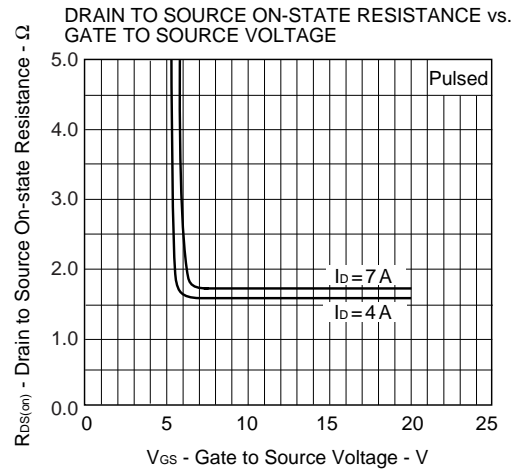
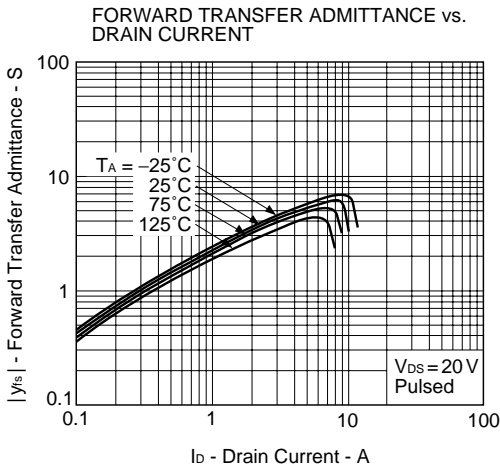
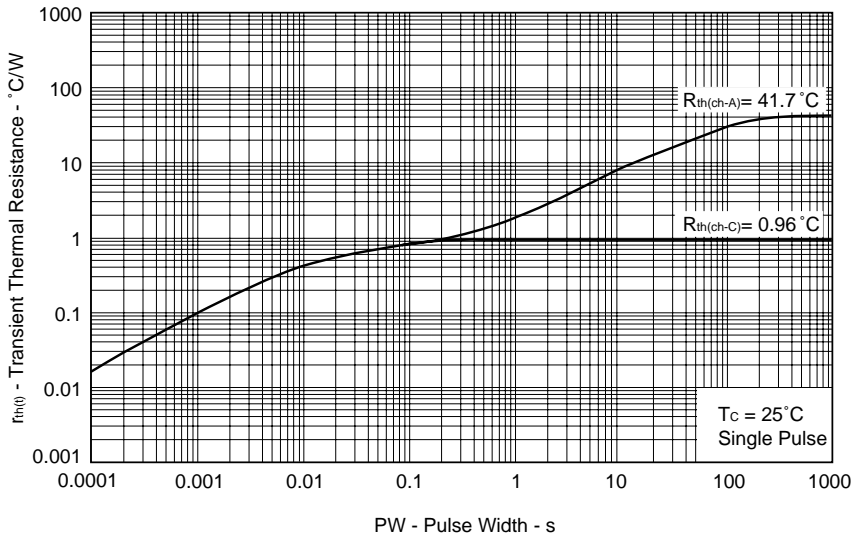
TEST CIRCUIT 3 GATE CHARGE



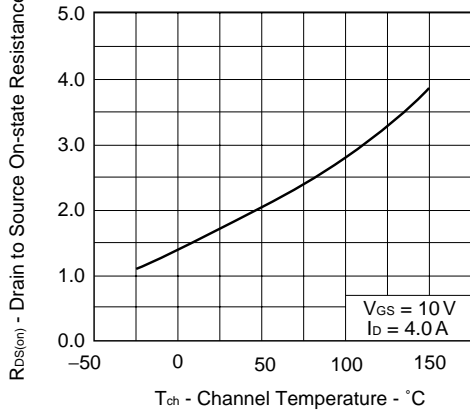
TYPICAL CHARACTERISTICS (T_A = 25°C)



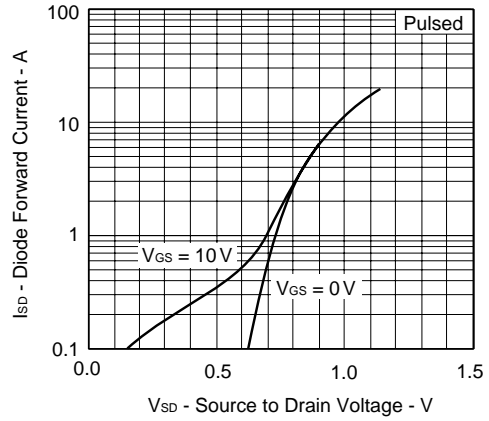
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



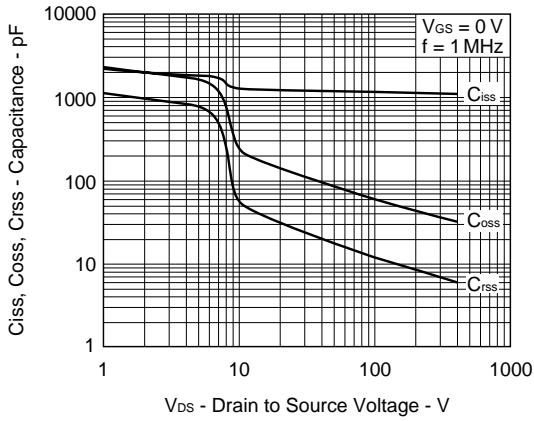
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



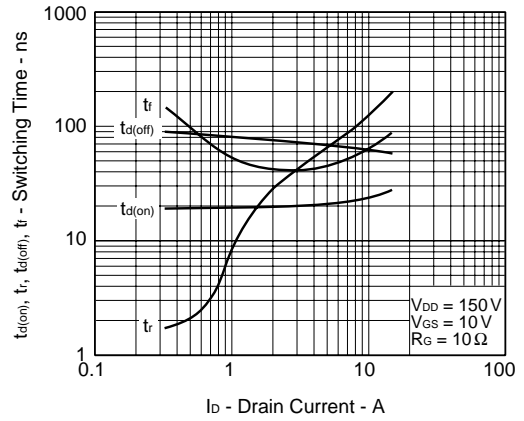
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



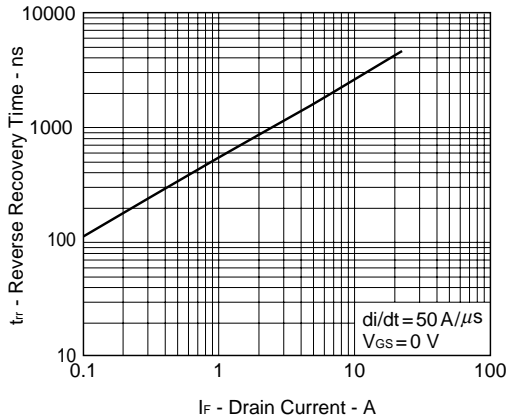
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



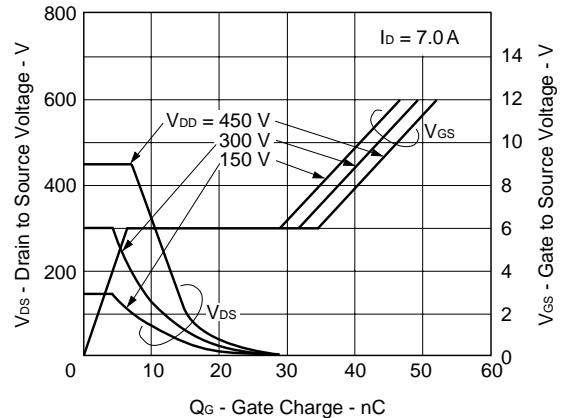
SWITCHING CHARACTERISTICS

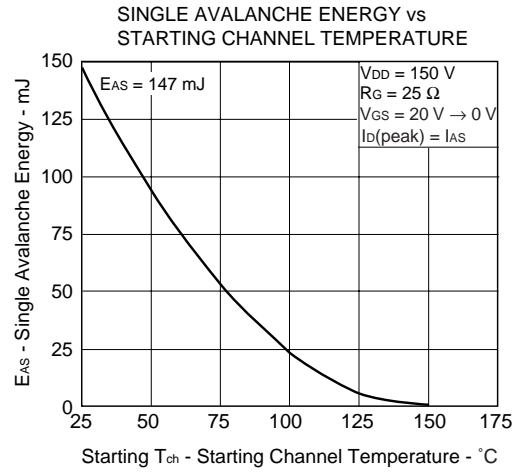
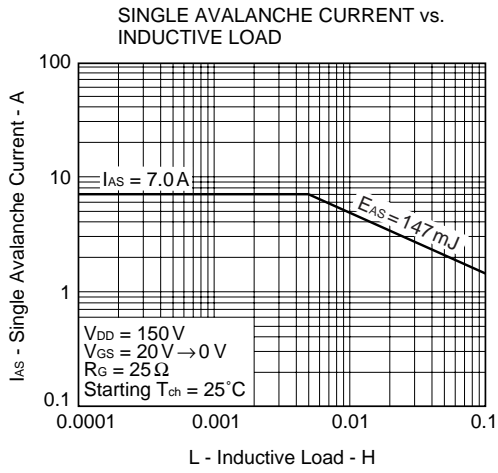


REVERSE RECOVERY TIME vs. DRAIN CURRENT



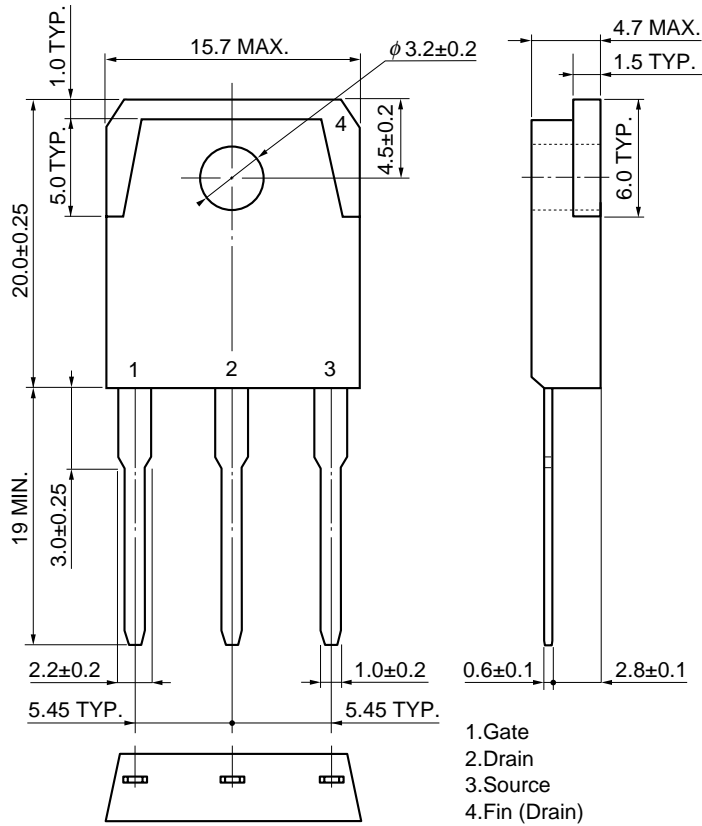
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



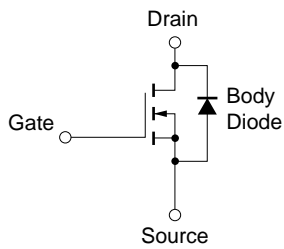


PACKAGE DRAWING (Unit : mm)

<R> TO-3P (MP-88)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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